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Dimensions	
Chip Size	2220
L	5.7mm +/-0.4mm
W	5mm +/-0.4mm
T	1.6mm +/-0.20mm
B	0.6mm +/-0.35mm

Packaging Specifications	
Packaging	T&R, 330mm, Plastic Tape
Packaging Quantity	4000

General Information	
Series	CAN SMD Indust 250
Style	SMD Chip
Description	SMD Chip, MLCC, AC Rated
Features	Temperature Stable, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Component Weight	190 mg
MSL	1

Specifications	
Capacitance	4700 pF
Measurement Condition	1 kHz 1.0Vrms
Capacitance Tolerance	20%
Voltage AC	250 VAC
Dielectric Withstanding Voltage	945 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	10 GOhms

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